



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. 10/666,399      Confirmation No. 8955  
Applicant: Michael S. Leung  
Filed: September 18, 2003  
Art Unit: 2814  
Examiner: Thao X. Le  
Attorney Doc. P0298US-7

Title: MOLDED CHIP FABRICATION METHOD AND APPARATUS

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

RESPONSE TO OFFICE ACTION

Dear Sir:

In response to the office action mailed November 18, 2004,  
please amend the above identified application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the claims** are reflected in the listing of which  
begins on page 4 of this paper.

**Amendments to the Drawings** begin on page 11 of this paper.

**Remarks** begin on page 12 of this paper.